

## ANISOTROPIC ACOUSTIC IMPEDANCE MATCHING MATERIAL RELATED APPLICATION

This application claims priority to U.S. Provisional Patent Application No. 60/440,660, filed January 16, 2003 and incorporates that application by reference.

### BACKGROUND OF THE INVENTION

**[0001]** For ultrasonic transducer devices, specifically for those that are based upon solid piezoelectric (SP) materials, such as solid lead zirconate-lead titanate (PZT) and polymer matrix piezoelectric (PMP) materials, it is imperative to install or bond acoustic impedance matching (Z matching) layers on the piezoelectric materials in order to optimize the ultrasound transduction into the medium of propagation. See, for example, U.S. Patent No. 6,311,573 incorporated herein by reference, and U.S. Patent Application No. 10/357,531 entitled "Piezoelectric Transducer With Gas Matrix", filed January 7, 2003. Current transducer devices utilize relatively low Z matching layers on the PZT or PMP transducers in order to achieve high transduction into low Z materials, such as water, tissue, polymers, etc. Similarly, relatively high Z matching layers are used to achieve high transduction in high Z materials, such as metals, ceramics, and their composites. This mechanism of Z matching significantly increases the efficiency of transmission of ultrasound in a given medium of propagation. However, utilization of current Z matching layers permits acoustical crosstalk between two closely lying transducers, as in the case of linear, phased, or matrix arrays. Crosstalk between two transducers that are physically connected to each other is the consequence of strong planar coupling of the piezoelectric materials. Though PMP materials reduce planar coupling because of the attenuating characteristics of the polymer between the rods of the SP materials, generally PZT, it is still not enough in applications that require high lateral and temporal resolution, such as in medical diagnostics and industrial non-destructive testing. The deleterious effects of planar coupling transferred in the Z matching layers are reduced, thus decreasing the signal-to-noise ratio, particularly in multi-element transducer arrays. This invention introduces a Z matching layer that significantly reduces the acoustical crosstalk, besides providing other benefits.

### SUMMARY OF THE INVENTION

**[0002]** Briefly, according to this invention, there is provided an impedance matching layer comprising a homogenous matrix material. The preferred thickness of the layer is one fourth of the wavelength at the frequency being transmitted. Embedded in the matrix are the fibers, clusters of fibers, or rods of another material perpendicular to the plane face of the layer as well as that of an adjacent piezoelectric material. The preferred diameter of the fibers, cluster

of fibers, or rods is between less than one hundredth of the wavelength to one wavelength of the frequency being transmitted in fibers, cluster of fibers, or rods. The length of the fibers, cluster of fibers, or rods is equal to the thickness of the homogeneous matrix. The homogeneous matrix material can be a dielectric or an electrically conductive material, such as electrically and non-electrically conductive polymers, ceramics, or their combinations. The fibers, cluster of fibers, or rods can be composed of metals, any electrically conductive material, or dielectric materials, such as ceramic or polymer, organic, pulp, paper, wood fibers or rods. The fibers, cluster of fibers, or rods must be exposed at least on the surfaces of the acoustic layer that is in contact with the piezoelectric material. The fiber orientation may be well defined or random and distributed in a homogeneous matrix.

#### BRIEF DESCRIPTION OF THE DRAWINGS

[0003] Further features and other objects and advantages of this invention will become apparent from the following detailed description made with reference to the drawings in which:

[0004] Fig. 1 is a schematic diagram illustrating the modes of vibration generated in a piezoelectric material when it is pulsed with an electrical signal;

[0005] Fig. 2 is a schematic diagram illustrating the effect of a Z matching layer according to this invention on the deleterious effects of planar coupling coefficient of a piezoelectric material;

[0006] Fig. 3 is a cross-sectional view of the material according to this invention;

[0007] Fig. 4 shows the top or bottom surface of the material according to a preferred embodiment;

[0008] Fig. 5 is a cross-sectional view of the material according to a preferred embodiment;

[0009] Fig. 6 is a view of a top or bottom surface of the material according to this invention;

[0010] Fig. 7 is a schematic drawing of a single element solid piezoelectric transducer;

[0011] Fig. 8 is a schematic drawing of a single element piezoelectric composite transducer; and

[0012] Fig. 9 is a schematic drawing of a multi-element transducer.

#### DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0013] When a piezoelectric material, such as a PZT disc, is excited by an electrical pulse, it vibrates in the thickness mode. The frequency of vibration is determined by its thickness. In the majority of ultrasound applications, this is the desired direction of vibration in the

medium of ultrasound transmission. Among other characteristics of the PZT material, the magnitude and efficiency of a transducer device is controlled by the electro-mechanical coupling coefficient in the thickness mode, denoted by  $k_t$ . However, with each electrical pulse applied, the PZT material also vibrates perpendicular to the thickness direction, that is, in the planar mode, denoted by  $k_p$  as shown in Fig. 1.

**[0014]** The effects of planar mode vibration  $k_p$  are extremely detrimental in the operation of the transducer because vibrations caused by planar coupling are transferred into anything that is in contact with the piezoelectric material. For a simple single element transducer, effects of planar coupling are transferred in the acoustic impedance matching layer, as well as in the housing that contains and supports the piezoelectric material and other materials. In the multi-element transducers, such as linear, matrix, or phased arrays, the effects of planar coupling are transferred to the adjacent transducers. Ultimately, in all cases, the resultant transducer device emits poor quality signals due to low signal-to-noise ratio, subsequently adversely affecting resolution, detectability, and efficiency. In general, the higher the  $k_p$ , the higher the noise. Therefore, it is necessary to have a material in front and/or back of the piezoelectric material that is characterized by acoustic transparency in the desired vibration direction (thickness mode) and acoustic opacity in the planar direction.

**[0015]** According to this invention, an anisotropic material is one composed of perpendicularly aligned fibers, cluster of fibers, or rods embedded in an otherwise homogeneous material. Combination of this material with a piezoelectric material is shown in Fig. 2. Used as an acoustic impedance matching layer, it effectively transfers ultrasound in the thickness mode, while it attenuates the deleterious effects of planar mode coupling. The former is the result of very low attenuation of ultrasound, while the latter is the result of extremely high attenuation caused by the scatter of planar mode vibration by the fibers, cluster of fibers, or rods.

**[0016]** Referring to Fig. 3, the solid lines are fibers, cluster of fibers, or rods 1 embedded in a homogeneous medium 2.

**[0017]** As shown in Figs. 3 and 4, when the fibers, clusters of fibers, or rods are embedded in the matrix of a solid or liquid medium, conductive or non-conductive fibers or rods 1 are embedded in polymer, ceramic, or a composite material, or even in a non-electrically conductive liquid medium 2.

**[0018]** As shown in Fig. 5, when fibers, cluster of fibers, or rods are embedded in an essentially gaseous medium, electrically conductive or non-conductive fibers, cluster of fibers, or rods 11 are aligned in the empty (air/gas filled) space 13 of a material with holes,

perforations, or cells, that run continuously perpendicular to the thickness of the material 14. As an example, honeycomb material, such as NOMEX, or any other non-electrically conductive material, is suitable. Referring to Fig. 6, the solid dots are the fibers, cluster of fibers, or rods 11 placed in empty space (air/gas) 13 in a perforated or celled material 14.

#### APPLICATIONS

**[0019]** Fig. 7 is a cross section of a transducer made by utilizing the material according to this invention with a solid piezoelectric material.

**[0020]** Referring to Fig. 8, a transducer comprises the impedance matching material according to this invention with a composite piezoelectric material.

**[0021]** Referring to Fig. 9, the bottom side of the piezoelectric material can be bonded with material according to this invention that is filled with electrically conductive or non-conductive fibers, cluster of fibers, or rods in a homogeneous medium. However, on the top side of the piezoelectric material, the fibers, cluster of fibers, or rods must be electrically conductive so that they are electrically connected or bonded with the top surface of the piezoelectric material. After the top Z matching layer has been cut up to the interface between the Z matching layer and the piezoelectric material to produce the desired number of transducers to form linear or matrix arrays, then the fibers, cluster of fibers, or rods within individual transducer sections can be connected with electrical wires.

**[0022]** Having thus described my invention in the detail and particularity required by the Patent Laws, what is desired protected by Letters Patent is set forth in the following claims.